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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Serial No.: 09/831,763

Filed: May 11, 2001

Inventor(s): Heinrich Meyer et al.

For: Method of Galvanically
Forming Conductor
Structures of High-Purity
Copper in the Production
of Integrated Circuits

Examiner: Mutschler, Brian L.

Art Unit: 1753

CERTIFICATE OF MAILING
DATE OF DEPOSIT: November 24, 2003

I hereby certify that this correspondence is being deposited with the United States Postal Service, postage paid, as first class mail under 37 C.F.R. §1.8, on the date indicated above and is addressed to Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.

Name of person mailing paper or fee: Ourmazd S. Ojan

Signature: *Ourmazd S. Ojan*

Attorney Docket No.: 071-01

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

COVER LETTER AND CERTIFICATE OF MAILING

Sir:

Enclosed and attached hereto are the following:

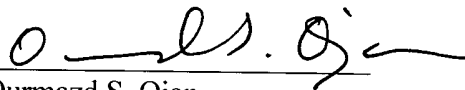
- 1) This cover letter (in triplicate);
- 2) Terminal disclaimer (1 page);
- 3) Petition for two-month extension of time (1 page; in duplicate);
- 4) Amendment Transmittal Form (in duplicate);
- 5) Amendment (9 pages);
- 6) Clean copy of Substitute Specification (23 pages including cover sheet);
- 7) Marked-up Substitute Specification (23 pages including cover sheet);
- 8) Replacement Abstract (2 pages including cover sheet);
- 9) Check in the amount of \$420.00 for the extension fee;

- 10) Check in the amount of \$110.00 for the disclaimer fee; and
- 11) Postcard to be date stamped and returned by PTO.

No additional fees are believed to be required at this time. In the event that additional fees are required with respect to this communication, the Commissioner is hereby authorized to charge any such fees, or credit any overpayment, to Paul & Paul deposit account number 16-0750.

Respectfully submitted,

November 24, 2003


Ourmazd S. Ojan
Reg. No. 38,065
Paul & Paul
2900 Two Thousand Market Street
Philadelphia, PA 19103
(215) 568-4900

Order No. 1895

AMENDMENT TRANSMITTAL LETTER (Large Entity)

Applicant(s): Heinrich Meyer et al.

Docket No.

071-01

Serial No.

09/831,763

Filing Date

05/11/2001

Examiner

Brian L. Mutschler

Group Art Unit

1753

Invention:

Method for Galvanically Forming Conductor Structures of High-Purity Copper in the Production of Integrated Circuits

TO THE ASSISTANT COMMISSIONER FOR PATENTS:

Transmitted herewith is an amendment in the above-identified application.

The fee has been calculated and is transmitted as shown below.

CLAIMS AS AMENDED

	CLAIMS REMAINING AFTER AMENDMENT	HIGHEST # PREV. PAID FOR	NUMBER EXTRA CLAIMS PRESENT	RATE	ADDITIONAL FEE
TOTAL CLAIMS	17 -	20 =	0 x	\$18.00	\$0.00
INDEP. CLAIMS	1 -	3 =	0 x	\$86.00	\$0.00
Multiple Dependent Claims (check if applicable) <input type="checkbox"/>					\$0.00
TOTAL ADDITIONAL FEE FOR THIS AMENDMENT					\$0.00

- ☒ No additional fee is required for amendment.
- ☐ Please charge Deposit Account No. _____ in the amount of _____
A duplicate copy of this sheet is enclosed.
- ☐ A check in the amount of _____ to cover the filing fee is enclosed.
- ☒ The Commissioner is hereby authorized to charge payment of the following fees associated with this communication or credit any overpayment to Deposit Account No. 16-0750
A duplicate copy of this sheet is enclosed.
- ☒ Any additional filing fees required under 37 C.F.R. 1.16.
- ☒ Any patent application processing fees under 37 CFR 1.17.


Signature

Dated: 11/24/2003

Ourmazd S. Ojan
Reg. No. 38,065
Paul & Paul
2000 Market Street
Suite 2900
Philadelphia, PA 19103
Phone: (215) 568-4900; FAX: (215) 567-5057

I certify that this document and fee is being deposited
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Signature of Person Mailing Correspondence

Ourmazd S. Ojan

Typed or Printed Name of Person Mailing Correspondence

CC: